

UNITED STATES PATENT APPLICATION

OF

HONG MAN MOON

FOR

**LIQUID CRYSTAL DISPLAY DEVICE AND
METHOD FOR MANUFACTURING THE SAME**

**LONG ALDRIDGE & NORMAN, LLP
701 PENNSYLVANIA AVENUE N.W.
SUITE 600, SIXTH FLOOR
WASHINGTON, DC 20004
TEL: 202/624-1200
FAX: 202/624-1298**

10025765-129801

[0001] This application claims the benefit of Korean Patent Application No. P2000-85558, filed on December 29, 2000, the entirety of which is hereby incorporated by reference for all purposes as if fully set forth herein.

BACKGROUND OF THE INVENTION

Field of the Invention

[0002] The present invention relates to a liquid crystal display (LCD) device, and more particularly, to an LCD device and a method for manufacturing the same that can remove a defect generated from polishing and etching of a glass substrate.

Background of the Related Art

[0003] Recently, research of flat panel displays such as liquid crystal displays (LCD), plasma display panels (PDP), electroluminescent displays (ELD), vacuum fluorescent displays (VFD), etc., is being performed, and these displays are being used in various apparatuses.

[0004] Among these displays, LCDs are most widely used in that they have good picture quality and low power consumption characteristics. They are being used as the display in portable televisions and notebook computers.

[0005] Portable televisions or notebook computers are obtaining their popularity because they are lightweight. A main component of technology development is to further decrease their weight. To this end, there are specific efforts to decrease the weight of the LCD itself.

[0006] Various ways for decreasing the weight of the LCD have been attempted. However, LCD structure and current technology limit the decrease of weight and size to the main elements of the LCD.

[0007] In the meantime, a glass substrate, which is one of the most basic elements of the LCD, still has a margin available for decreasing the weight of the LCD according to developments in processing technologies. Since the glass substrate occupies most of the total weight of the LCD, research for decreasing the weight of the glass substrate is being performed for the purpose of decreasing the weight of the LCD.

[0008] In order to decrease the weight of the glass substrate, its thickness should be decreased incrementally. However, if the thickness decreases below a specific value, the glass substrate is broken during its processing or cracks are generated. Therefore, there is a limitation in decreasing the thickness of the glass substrate.

[0009] As a way for decreasing the thickness of the glass substrate, after an LCD panel is fabricated using a glass substrate having the specific thickness or more, a surface of the glass substrate is etched by dipping the glass substrate in an etching bath in which an etchant is contained.

[0010] This method, however, has disadvantages in that the glass substrate is disproportionally etched due to the incompleteness of the glass substrate itself, or foreign particles generated during the etching process stick to the etched surface of the glass substrate and thus the surface of the glass substrate becomes irregular.

[0011] A general LCD device and a method for manufacturing the same will be described with reference to following drawings.

[0012] FIG. 1 is a sectional view of the general LCD device.

[0013] As shown in FIG. 1, in the general LCD device, first glass substrate 3 and second glass substrate 4 are assembled together by a sealing pattern 6 to form some space therebetween. The general LCD device includes an LCD panel consisting of a liquid crystal 5 injected into the space between the first glass substrate 3 and second glass substrate 4 and charged by an electric field; polarizers 2-1 and 2-2 formed in upper and lower portions of the LCD panel; and a backlight 1 providing light from the back of the polarizer 2-1.

[0014] A method for manufacturing the LCD panel of the aforementioned LCD device will be described briefly.

[0015] A plurality of the LCD panels according to desired sizes are formed on a pair of large sized glass substrates having spaces corresponding to a plurality of the LCD devices. The pair of large sized glass substrates are assembled together to form some space therebetween, and then are cut according to the respective LCD panels. Subsequently, the liquid crystal is injected into the spaces between the glass substrates of the cut LCD panel.

[0016] Gate lines and data lines are formed on one of the glass substrates in each LCD panel to define pixel regions in a matrix arrangement. Also, the gate lines are formed to cross the data lines. A thin film transistor and a pixel electrode are arranged in each of the respective pixel regions. Then, a color filter layer and a common electrode are arranged on the other glass substrate in each LCD panel. Such glass substrates are aligned with each other, and are assembled with each other by a sealant to form space between the glass substrates. As aforementioned, the glass substrates are cut according to the respective LCD panels, and the liquid crystal is injected therebetween.

[0017] In this process, the assembled glass substrates are etched by etching equipment to reduce the weight of the LCD device before cutting the pair of glass substrates according to the respective LCD panels.

[0018] Prior to etching, a signal line, a thin film transistor, a pixel electrode, a color filter, and a common electrode (not shown) are formed on the first and second glass substrates having a thickness (t) of about 1.1mm, and then the first and second glass substrates are assembled with each other as shown in FIG. 2A.

[0019] As shown in FIG. 2B, after the first and second glass substrates are assembled together, outer surfaces of the first and second glass substrates having a thickness (t') of about 0.5mm, for example, are etched by chemical etching or mechanical polishing processes.

[0020] However, in the etching process, grooves 11 or scratches occur in the glass substrates. For this reason, the outer surfaces of the glass substrates assembled with each other become irregular. This results in the occurrence of dot or spot defects on a screen during driving the LCD device.

5

SUMMARY OF THE INVENTION

[0021] Accordingly, the present invention is directed to a liquid crystal display (LCD) device that substantially obviates one or more problems due to limitations and disadvantages of the related art.

10 [0022] An advantage of the present invention is to provide an LCD device and a method for manufacturing the same, in which a glass organic film such as benzocyclobutene (BCB) and photo-acrylate is deposited on a surface of a glass substrate damaged by etching and polishing processes, so as to repair the damaged surface of the glass substrate.

15 [0023] Additional advantages, and features of the invention will be set forth in part in the description which follows and in part will become apparent to those having ordinary skill in the art upon examination of the following or may be learned from practice of the invention. The objectives and other advantages of the invention may be realized and attained by the structure particularly pointed out in the written description and claims hereof as well as the appended drawings.

20 [0024] To achieve these and other advantages and in accordance with the purpose of the invention, as embodied and broadly described herein, an LCD device according to the present invention includes first and second substrates assembled together with some spaces therebetween, each having an etched outer surface; and a passivation film on an outer surface of the first and second substrates.

25 [0025] In another aspect of the present invention, a method for manufacturing an LCD device includes the steps of preparing first and second substrates; assembling the first

and second substrates together, etching surfaces of the assembled first and second substrates, and forming a passivation film on the surfaces of the first and second substrates.

[0026] Herein, the passivation film includes an organic film. The organic film is formed by a spin-coating process. The organic film includes BCB or photo-acrylate. Also, the organic film is formed of a material in which a refractive index difference with the glass substrate is within about 10%.

[0027] In one embodiment of the present invention, the passivation film is formed on the glass substrate. Therefore, it is possible to prevent the glass substrate from being formed at an uneven thickness, which is generated by a scratch of the glass substrate when the glass substrate is unevenly etched.

[0028] It is to be understood that both the foregoing general description and the following detailed description of the present invention are exemplary and explanatory and are intended to provide further explanation of the invention as claimed.

BRIEF DESCRIPTION OF THE DRAWINGS

[0029] The accompanying drawings, which are included to provide a further understanding of the invention and are incorporated in and constitute a part of this application, illustrate embodiments of the invention and together with the description serve to explain the principles of the invention.

[0030] In the drawings:

[0031] FIG. 1 is a sectional view of a general LCD device;

[0032] FIG. 2A and FIG. 2B are sectional views of an LCD panel before and after etching according to a related art;

[0033] FIG. 3A to FIG. 3C are sectional views illustrating manufacturing process steps of a display panel according to the present invention; and

[0034] FIG. 4 is a sectional view of the display panel according to the present invention.

DETAILED DESCRIPTION OF THE ILLUSTRATED EMBODIMENT

5 [0035] Reference will now be made in detail to an embodiment of the present invention, examples of which are illustrated in the accompanying drawings.

[0036] An LCD device and a method for manufacturing the same will be described with reference to FIG. 3A to FIG. 3C. First, as shown in FIG. 3A, a plurality of gate lines and data lines (not shown) are formed on a first glass substrate 23 at a thickness of "t" to
10 define pixel regions of a matrix arrangement (not shown). Also, the gate lines are formed to cross the data lines. Then, a thin film transistor and a pixel electrode are formed in the respective pixel regions (not shown).

[0037] A black matrix layer (light-shielding layer), a color filter layer and a common electrode are formed on a second glass substrate 24 at a thickness of "t" (not
15 shown).

[0038] Such first and second glass substrates are assembled together by a sealing pattern 26 to form some space between the substrates. As shown in FIG. 3A, a liquid crystal 25 is injected into the space between the first glass substrate 23 and second glass substrate 24.

20 [0039] As shown in FIG. 3B, surfaces of the first and second glass substrates are thinned to a specific thickness (t') by chemical etching and/or mechanical polishing processes to thin the thickness of the first glass substrate 23 and second glass substrate 24 where the liquid crystal 25 will be injected.

[0040] The chemical etching process includes dipping the glass substrate into an
25 etchant such as HydroFlouric acid (HF) solution, and then etching the glass substrate by exothermic reaction between the glass substrate and the etchant. In this method, a

mechanical force is not applied to the glass substrate, so that the glass substrate is not damaged.

[0041] The mechanical polishing process includes polishing the assembled substrates with sandpaper or polisher while spraying coolant on the assembled substrates.

5 [0042] As shown in FIG. 3B, if the first and second glass substrates are etched by the chemical etching and/or the mechanical polishing processes, grooves 11 are formed in the surface of the substrate or scratches occur on the surface of the substrate due to unevenness of the etching process.

10 [0043] Accordingly, as shown in FIG. 3C, the passivation film 12 is thinly formed on the surfaces of the first substrate 23 and second glass substrate 24.

[0044] The passivation film 12 is formed of an organic film in which a refractive index difference of the glass substrates is within about 10%. The organic film is formed by a spin coating process. The organic film can include BenzoCycloButene (BCB) or photo-acrylate.

15 [0045] In this method, if both of the top and bottom substrates are formed of glass, the top and bottom substrates are thin. Also, even if one of the top and bottom substrates is formed of glass, the top and bottom substrates are thin.

20 [0046] The chemical etching process is performed in an etching apparatus provided with etching, cleaning and drying portions. In the chemical etching process, the substrates are etched by the etchant filled in an etching bath of the etching portion, and then the etchant remaining on a surface of the substrate is removed in the cleaning portion. Subsequently, the substrate is dried in the drying portion, so that the substrate is completed.

25 [0047] In finishing the etching process of the substrate, the fine scratches of the substrate are polished. Then, a plurality of liquid crystal cells, which are formed in one substrate, are divided into single cells by a cutting process. After cutting the substrate, the liquid crystal 25 is injected into the substrate through a liquid crystal injection hole and the

cut substrates are sealed by the sealing pattern 26. Therefore, the process steps are completed.

[0048] The substrates may be assembled together by another method, and then the liquid crystal is injected therebetween. Subsequently, the etching process and its later process steps are performed. The glass substrates 23 and 24 planarized by forming such a passivation film 12 are applicable to not only the LCD device but also the display panel.

[0049] FIG. 4 is a sectional view of an LCD panel according to the present invention.

[0050] The LCD device according to the present invention has the following structure.

[0051] As shown in FIG. 4, the LCD device includes the first glass substrate 23, the second glass substrate 24, the liquid crystal 25, and the passivation film 12. In the first glass substrate 23, a plurality of gate lines and data lines are formed to define the pixel regions of a matrix arrangement (not shown). Also, the gate lines are formed to cross the data lines. Then, a plurality of thin film transistors and pixel electrodes are formed in the respective pixel regions (shown only as a unit for convenience) on the first glass substrate. The light-shielding layer, the color filter layer and the common electrode are formed in the second glass substrate 24 (not shown). The first and second glass substrates are assembled together with some spaces therebetween by the sealing pattern, and then the liquid crystal 25 is injected between the glass substrates. The passivation film 12 is coated on the surface of the assembled first and second glass substrates.

[0052] In FIG. 4, a gate electrode 13a connected with the gate line (not shown) is formed on the first glass substrate 23, and a gate insulating film 13b is formed on the surface of the first substrate including the gate electrode 13a. Also, an island shaped semiconductor layer 13c is formed on the gate insulating film 13b at an upper portion of the gate electrode 13a. A source electrode 13d and a drain electrode 13e are formed at

respective sides of the semiconductor layer 13c to form a thin film transistor. A pixel electrode 15 is formed in one portion of the thin film transistor to connect with the drain electrode 13e.

5 [0053] A sealing pattern 26 may also be formed to prevent the etchant from being permeated into the substrates.

[0054] A polarizer (not shown) is attached outside the passivation film 12, and a backlight (not shown) that serves as a light source is formed in a lower portion of the first glass substrate 23.

10 [0055] As has been explained, the LCD device and the method for manufacturing the same according to the present invention have the following advantages.

[0056] In the LCD panel of the present invention, since a stable and inexpensive glass substrate is used, production yield is improved.

15 [0057] Also, since the passivation film such as BCB and photo-acrylate is deposited on the glass substrate damaged by the etching process, the glass substrate is protected and flattened, thereby improving picture quality of the LCD panel.

20 [0058] It will be apparent to those skilled in the art that various modifications and variation can be made in the present invention without departing from the spirit or scope of the invention. Thus, it is intended that the present invention cover the modifications and variations of this invention provided they come within the scope of the appended claims and their equivalents.